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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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HAT2099H

Silicon N Channel Power MOS FET
Power Switching

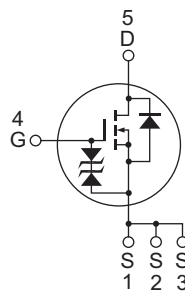
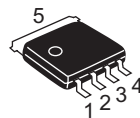
REJ03G1187-0500
(Previous: ADE-208-1432C)
Rev.5.00
Sep 07, 2005

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
 $R_{DS(on)} = 2.9 \text{ m}\Omega$ typ. (at $V_{GS} = 10 \text{ V}$)

Outline

RENESAS Package code: PTZZ0005DA-A
(Package name: LFAK)



1, 2, 3 Source
4 Gate
5 Drain

Absolute Maximum Ratings

(Ta = 25°C)

| Item | Symbol | Value | Unit |
|--|--|-------------|------|
| Drain to source voltage | V _{DSS} | 30 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | I _D | 50 | A |
| Drain peak current | I _{D (pulse)} ^{Note 1} | 200 | A |
| Body-drain diode reverse drain current | I _{DR} | 50 | A |
| Avalanche current | I _{AP} ^{Note 3} | 5 | A |
| Avalanche energy | E _{AR} ^{Note 3} | 2.5 | mJ |
| Channel dissipation | P _{ch} ^{Note 2} | 30 | W |
| Channel temperature | T _{ch} | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |

- Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%
 2. T_c = 25 °C
 3. Value at T_{ch} = 25°C, R_g ≥ 50 Ω

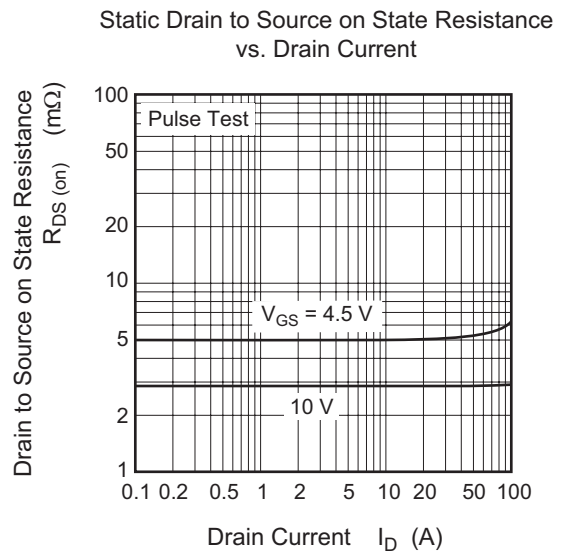
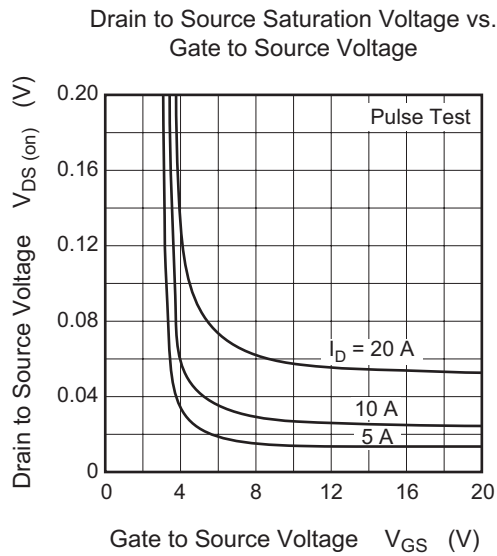
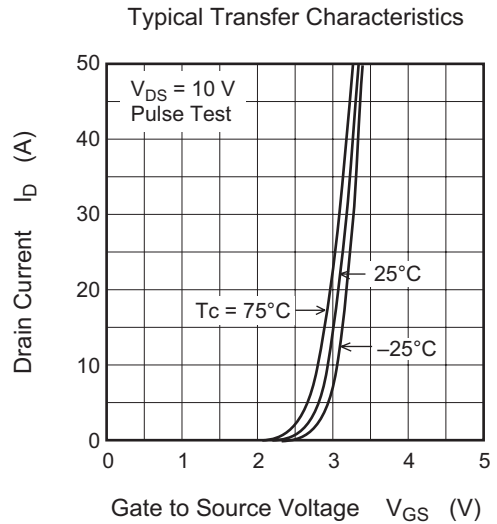
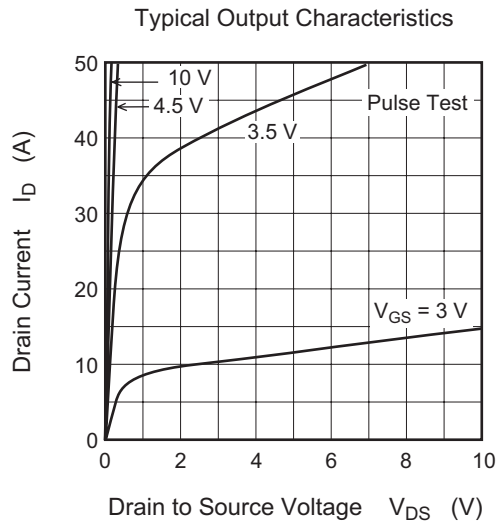
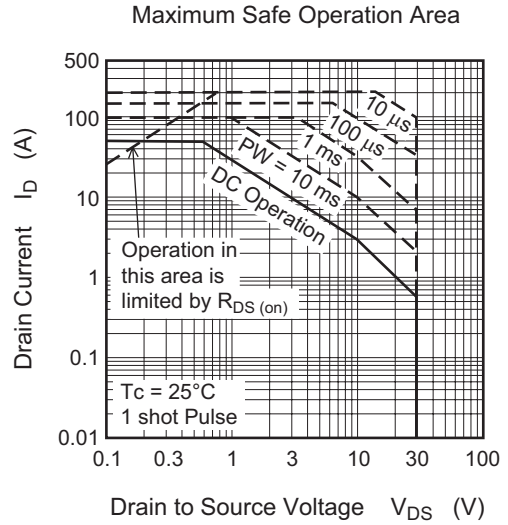
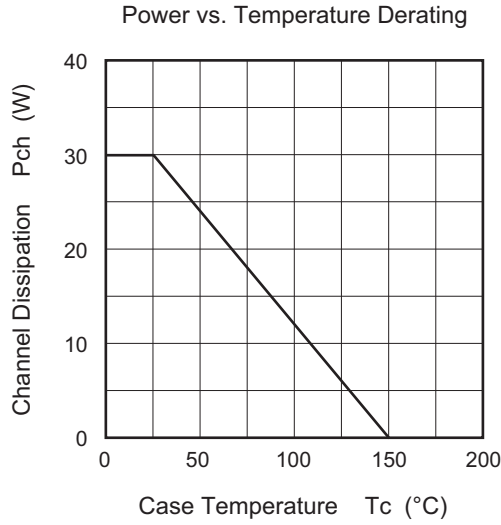
Electrical Characteristics

(Ta = 25°C)

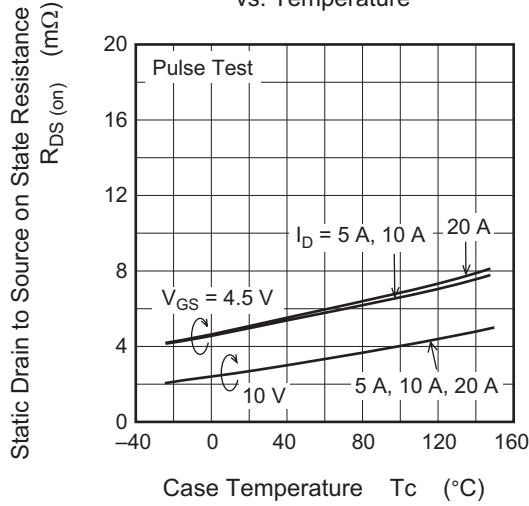
| Item | Symbol | Min | Typ | Max | Unit | Test Conditions |
|--|-----------------------|-----|------|------|------|---|
| Drain to source breakdown voltage | V _{(BR) DSS} | 30 | — | — | V | I _D = 10 mA, V _{GS} = 0 |
| Gate to source breakdown voltage | V _{(BR) GSS} | ±20 | — | — | V | I _G = ±100 μA, V _{DS} = 0 |
| Gate to source leak current | I _{GSS} | — | — | ±10 | μA | V _{GS} = ±16 V, V _{DS} = 0 |
| Zero gate voltage drain current | I _{DSS} | — | — | 1 | μA | V _{DS} = 30 V, V _{GS} = 0 |
| Gate to source cutoff voltage | V _{GS (off)} | 1.0 | — | 2.5 | V | V _{DS} = 10 V, I _D = 1 mA |
| Static drain to source on state resistance | R _{DS (on)} | — | 2.9 | 3.7 | mΩ | I _D = 25 A, V _{GS} = 10 V ^{Note 4} |
| | R _{DS (on)} | — | 5.0 | 7.3 | mΩ | I _D = 25 A, V _{GS} = 4.5 V ^{Note 4} |
| Forward transfer admittance | y _{fs} | 39 | 65 | — | S | I _D = 25 A, V _{DS} = 10 V ^{Note 4} |
| Input capacitance | C _{iss} | — | 4750 | — | pF | V _{DS} = 10 V |
| Output capacitance | C _{oss} | — | 1180 | — | pF | V _{GS} = 0 |
| Reverse transfer capacitance | C _{rss} | — | 650 | — | pF | f = 1 MHz |
| Total gate charge | Q _g | — | 75 | — | nC | V _{DD} = 10 V |
| Gate to source charge | Q _{gs} | — | 16 | — | nC | V _{GS} = 10 V |
| Gate to drain charge | Q _{gd} | — | 14 | — | nC | I _D = 50 A |
| Turn-on delay time | t _{d (on)} | — | 26 | — | ns | V _{GS} = 10 V, I _D = 25 A |
| Rise time | t _r | — | 60 | — | ns | V _{DD} ≅ 10 V |
| Turn-off delay time | t _{d (off)} | — | 85 | — | ns | R _L = 0.4 Ω |
| Fall time | t _f | — | 26 | — | ns | R _g = 4.7 Ω |
| Body-drain diode forward voltage | V _{DF} | — | 0.85 | 0.98 | V | I _F = 50 A, V _{GS} = 0 ^{Note 4} |
| Body-drain diode reverse recovery time | t _{rr} | — | 60 | — | ns | I _F = 50 A, V _{GS} = 0 di _F /dt = 50 A/μs |

Note: 4. Pulse test

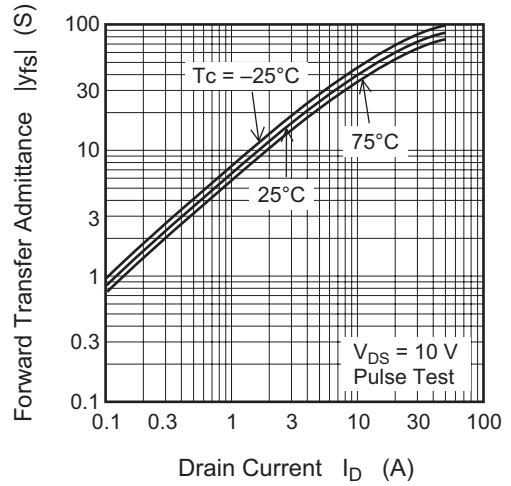
Main Characteristics



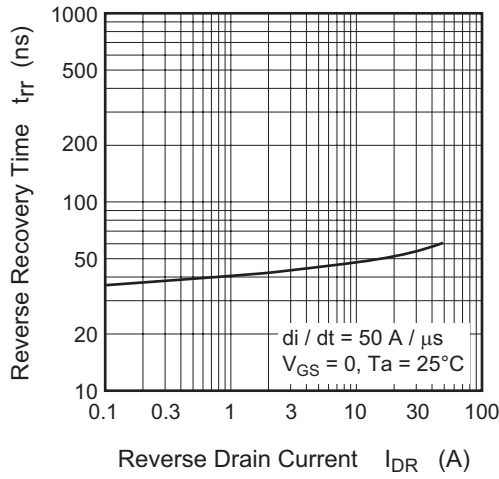
Static Drain to Source on State Resistance vs. Temperature



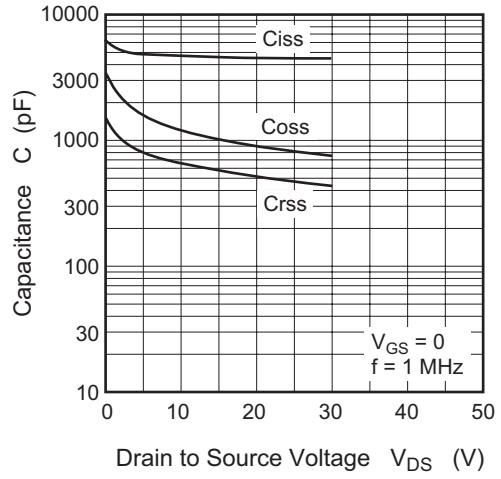
Forward Transfer Admittance vs. Drain Current



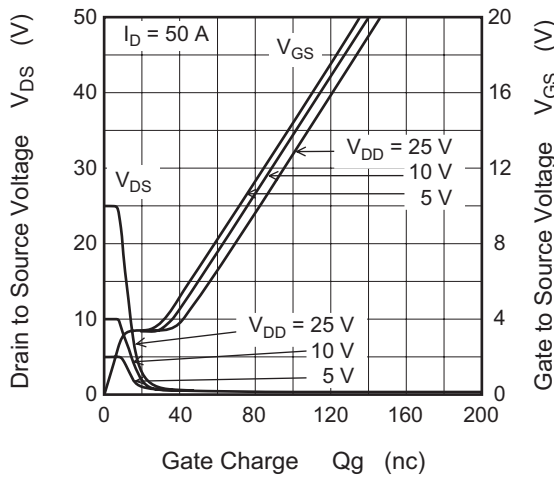
Body-Drain Diode Reverse Recovery Time



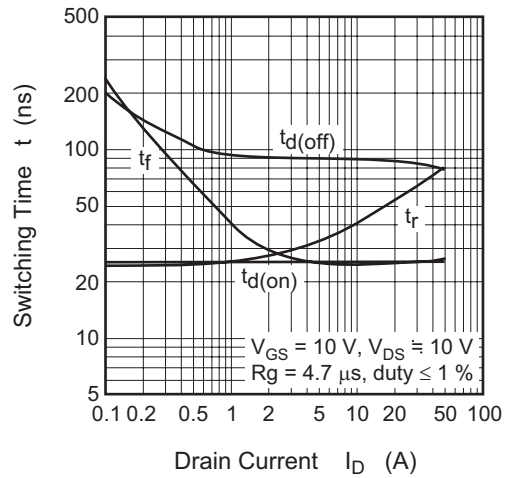
Typical Capacitance vs. Drain to Source Voltage

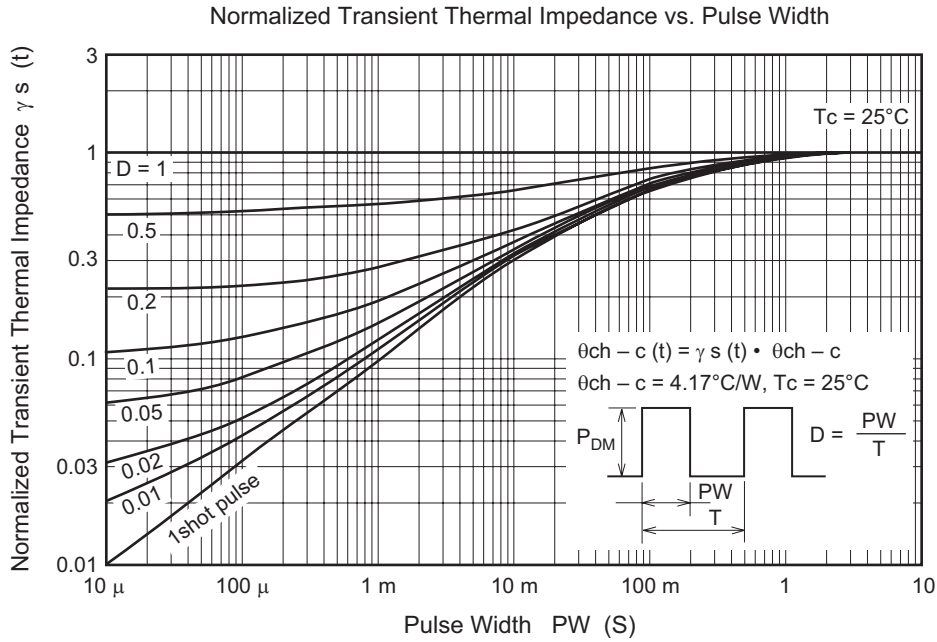
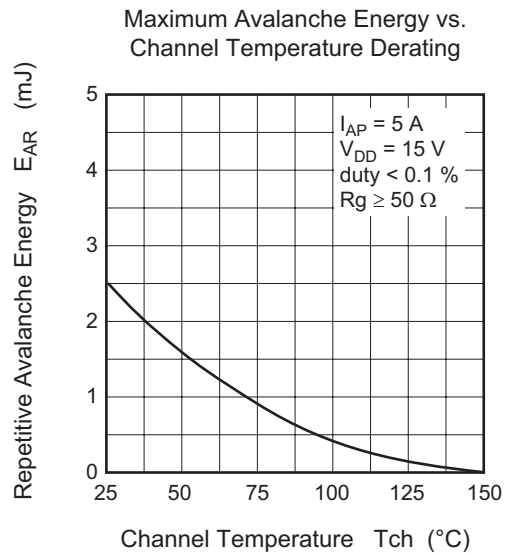
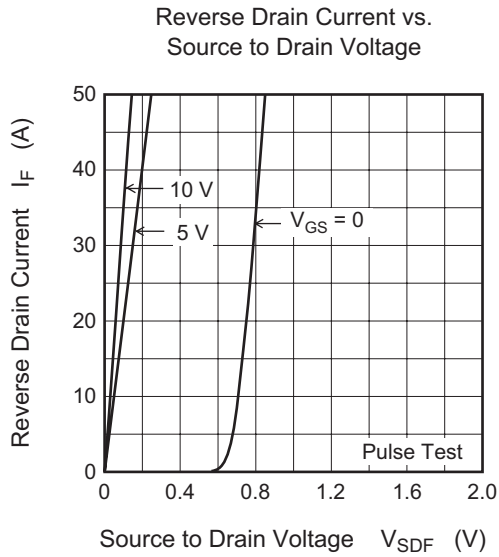


Dynamic Input Characteristics

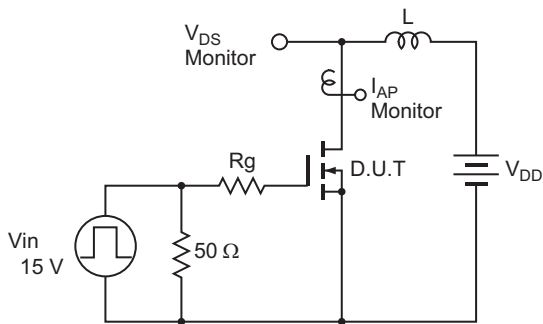


Switching Characteristics

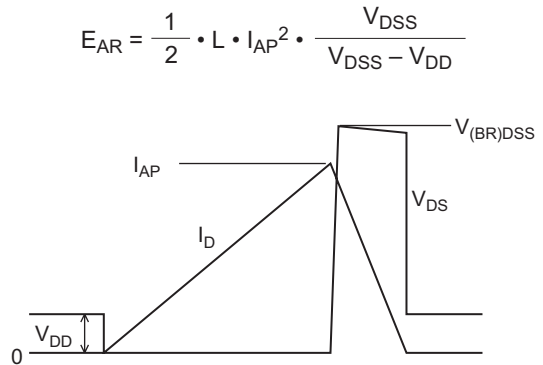


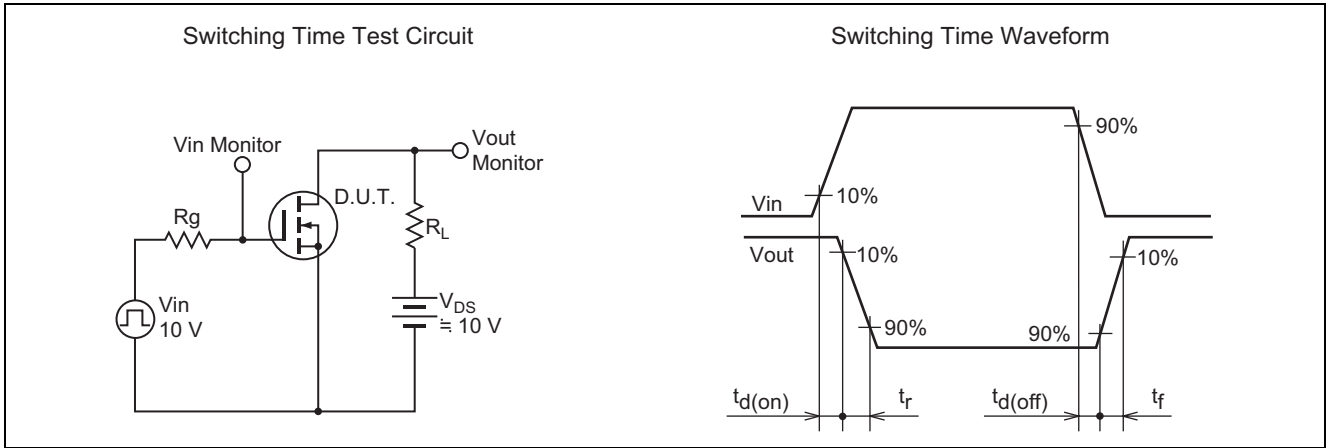


Avalanche Test Circuit

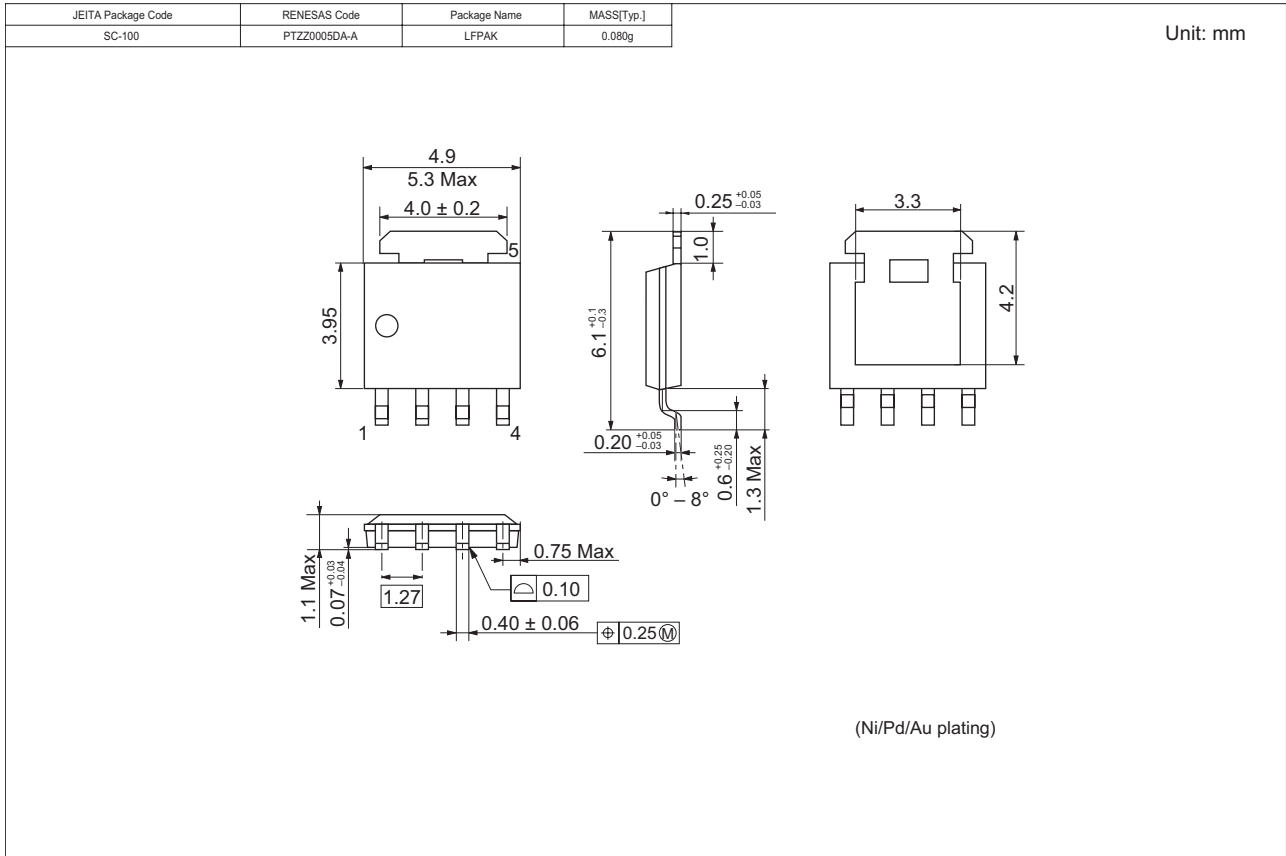


Avalanche Waveform





Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|---------------|----------|--------------------|
| HAT2099H-EL-E | 2500 pcs | Taping |

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